



Multiscale Heat and Mass Transfer and Artificial Intelligence

Guest Editors:

Dr. Guice Yao

School of Aeronautic Science and Engineering, Beihang University, Beijing 100191, China

Dr. Chuang Wen

School of Construction Management and Engineering, University of Reading, Reading RG6 6AH, UK

Dr. Jin Zhao

School of Aeronautic Science and Engineering, Beihang University, Beijing 100191, China

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Message from the Guest Editors

Heat and mass transfer is an important research area that is relevant to a variety of emerging technologies in the fields of energy, low-carbon energy utilization, chemical engineering and aerospace engineering, etc. Multiscale simulation techniques and complement experimental studies from atomic to macroscopic scale brought about numerous breakthroughs. Recently, cutting-edge artificial intelligence (AI) technologies have emerged as powerful tools to accelerate fundamental physics-based understanding and applications in heat and mass transfer research. In view of these achievements, this Special Issue is devoted to showcasing cutting-edge research and developments in the field of multiscale heat and mass transfer and AI technologies.

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multiscale modelling
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Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo
Dipartimento di Fisica,
Politecnico di Milano, Piazza L.
da Vinci 32, 20133 Milano, Italy

Message from the Editor-in-Chief

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Applied Sciences Editorial Office
MDPI, Grosspeteranlage 5
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